

FAIRCHILD

A Schlumberger Company

**2N6761/2N6762
N-Channel Power MOSFETs,
4.5 A, 450 V/500 V**

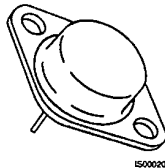
T-39-11

Power And Discrete Division

Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltage, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.

TO-204AA



1500020F

- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $R_{DS(on)}$, SOA and $V_{GS(th)}$ Specified at Elevated Temperature
- Rugged

2N6761
2N6762

Maximum Ratings

| Symbol | Characteristic | Rating 2N6762 | Rating 2N6761 | Unit |
|----------------|---|------------------|------------------|--------------------|
| V_{DSS} | Drain to Source Voltage | 500 | 450 | V |
| V_{DGR} | Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$ | 500 | 450 | V |
| V_{GS} | Gate to Source Voltage | ± 20 | ± 20 | V |
| T_J, T_{stg} | Operating Junction and Storage Temperatures | -55 to +150 | -55 to +150 | $^{\circ}\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purposes, 1/16" From Case for 10 s | 300 | 300 | $^{\circ}\text{C}$ |

Maximum On-State Characteristics

| | | | | |
|--------------|--|------------|------------|----------|
| $R_{DS(on)}$ | Static Drain-to-Source On Resistance | 1.5 | 2.0 | Ω |
| I_D | Drain Current Continuous at $T_C = 25^{\circ}\text{C}$ Continuous at $T_C = 100^{\circ}\text{C}$ | 4.5 3.0 | 4.0 2.5 | A |
| I_{DM} | Pulsed | 7.0^2 | 6.0^2 | |

Maximum Thermal Characteristics

| | | | | |
|-----------------|--|----------|----------|-----------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 1.67 | 1.67 | $^{\circ}\text{C}/\text{W}$ |
| P_D | Total Power Dissipation at $T_C = 25^{\circ}\text{C}$ at $T_C = 100^{\circ}\text{C}$ | 75 30 | 75 30 | W |
| | Linear Derating Factor | 0.6 | 0.6 | W/ $^{\circ}\text{C}$ |

Notes

All values are JEDEC registered except as noted. For information concerning connection diagram and package outline, refer to Section 7.

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Characteristic | Min | Max | Unit | Test Conditions |
|--|--|------------------|-----------------|----------------|--|
| Off Characteristics | | | | | |
| $V_{(BR)DSS}$ | Drain Source Breakdown Voltage ¹ 2N6762 2N6761 | | | V | $V_{GS} = 0\text{ V}, I_D = 4\text{ mA}$ |
| | | 500 ² | | | |
| | | 450 ² | | | |
| I_{DSS} | Zero Gate Voltage Drain Current | | 1 | mA | $V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}$ $V_{DS} = 0.8 \times \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}, T_C = 125^\circ\text{C}$ |
| | | | 4 | | |
| I_{GSS} | Gate-Body Leakage Current | | ± 100 | nA | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$ |
| On Characteristics | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | 2.0 | 4.0 | V | $I_D = 1.0\text{ mA}, V_{DS} = V_{GS}$ |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance ¹ 2N6762 2N6761 2N6762 2N6761 | | | Ω | $V_{GS} = 10\text{ V}$ $I_D = 3.0\text{ A}$ $I_D = 2.5\text{ A}$ $I_D = 3.0\text{ A}, T_C = 125^\circ\text{C}$ $I_D = 2.5\text{ A}, T_C = 125^\circ\text{C}$ |
| | | | 1.5 | | |
| | | | 2.0 | | |
| | | | 3.3 | | |
| | | | 4.4 | | |
| $V_{DS(on)}$ | Drain-Source On-Voltage ¹ 2N6762 2N6761 | | 7.7 | V | $V_{GS} = 10\text{ V}$ $I_D = 4.5\text{ A}$ $I_D = 4.0\text{ A}$ |
| | | | 8.0 | | |
| | | | | | |
| g_{fs} | Forward Transconductance ¹ | 2.5 | 7.5 | S (Ω) | $V_{DS} = 15\text{ V}, I_D = 3.0\text{ A}$ |
| Dynamic Characteristics | | | | | |
| C_{iss} | Input Capacitance | 350 | 800 | pF | $V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$ |
| C_{dss} | Output Capacitance | 25 | 200 | pF | |
| C_{res} | Reverse Transfer Capacitance | 15 | 60 | pF | |
| Switching Characteristics ($T_C = 25^\circ\text{C}$, Figures 9, 10) | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | | 30 | ns | $V_{DD} = 225\text{ V}, I_D = 3.0\text{ A}$ $V_{GS} = 10\text{ V}, R_{GEN} = \Omega$ $R_{GS} = 15\ \Omega$ |
| t_r | Rise Time | | 30 | ns | |
| $t_{d(off)}$ | Turn-Off Delay Time | | 55 | ns | |
| t_f | Fall Time | | 30 | ns | |
| Q_g | Total Gate Charge | | 30 ² | nC | $V_{GS} = 10\text{ V}, I_D = 7.0\text{ A}$ $V_{DD} = 180\text{ V}$ |

Electrical Characteristics (Cont.) ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Characteristic | Min | Typ | Max | Unit | Test Conditions |
|---|---|-------------|---------|------------|---------------|--|
| Source-Drain Diode Characteristics | | | | | | |
| I_S | Continuous Source Current 2N6762 2N6761 | | | 4.5 4.0 | A | |
| I_{SM} | Pulsed Source Current 2N6762 2N6761 | | | 7.0 6.0 | A | |
| V_{SD} | Diode Forward Voltage 2N6762 2N6761 | 0.7 0.65 | | 1.4 1.3 | V | $V_{GS} = 0\text{ V}$ $I_S = 4.5\text{ A}$ $I_S = 4.0\text{ A}$ |
| t_{rr} | Reverse Recovery Time | | 520^2 | | ns | $V_{GS} = 0\text{ V}$, $T_J = 150^\circ\text{C}$ $I_F = I_{SM}$, $dI_F/dt = 100\text{ A}/\mu\text{S}$ |
| Q_{RR} | Reverse Recovery Charge | | 7.0^2 | | μC | $V_{GS} = 0\text{ V}$, $T_J = 150^\circ\text{C}$ $I_F = I_{SM}$, $dI_F/dt = 100\text{ A}/\mu\text{S}$ |

Notes

1. Pulse test: Pulse width $\leq 300\ \mu\text{s}$, Duty cycle $\leq 1\%$
2. Non-JEDEC registered value.

Typical Performance Curves

Figure 1 Output Characteristics

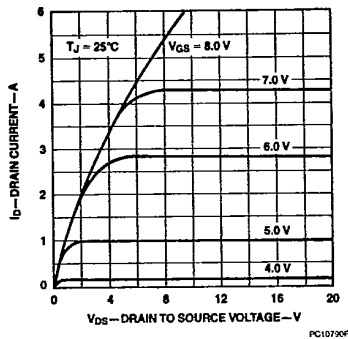
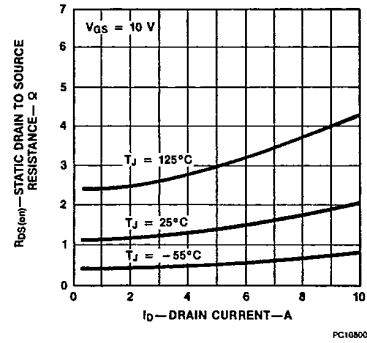


Figure 2 Static Drain to Source Resistance vs Drain Current



2N6761/2N6762

T-39-11

Typical Performance Curves (Cont.)

Figure 3 Transfer Characteristics

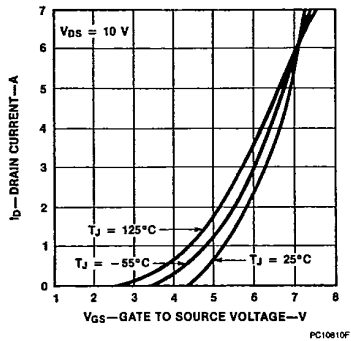


Figure 4 Temperature Variation of Gate to Source Threshold Voltage

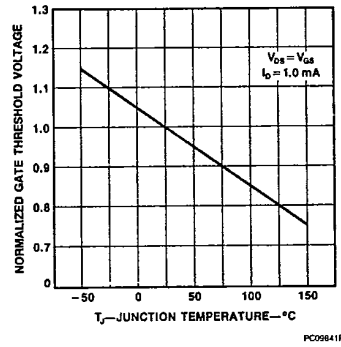


Figure 5 Capacitance vs Drain to Source Voltage

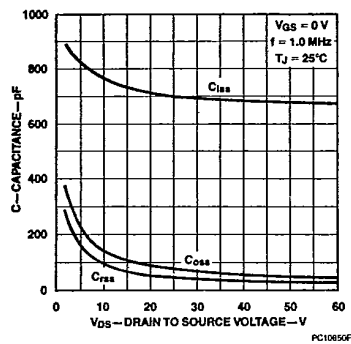


Figure 6 Gate to Source Voltage vs Total Gate Charge

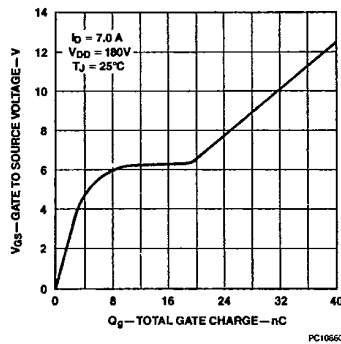


Figure 7 Forward Biased Safe Operating Area

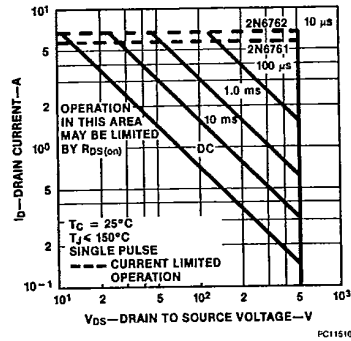
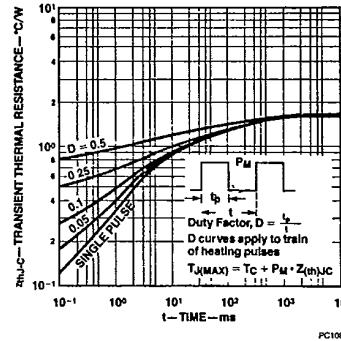
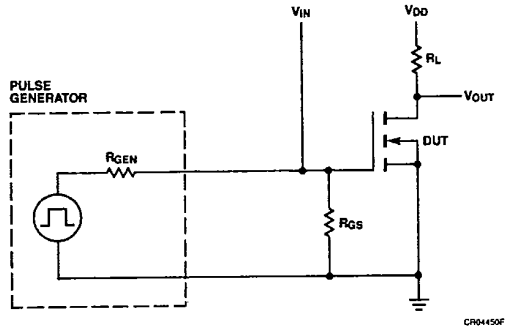


Figure 8 Transient Thermal Resistance vs Time



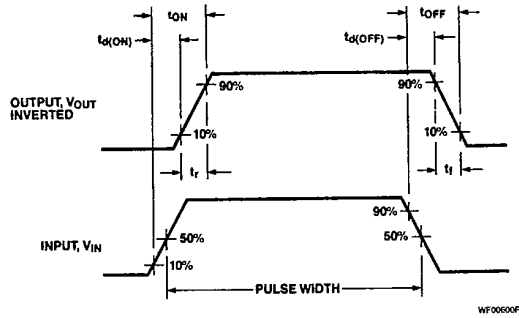
Typical Electrical Characteristics

Figure 9 Switching Test Circuit



CR04450F

Figure 10 Switching Waveforms



WF00000F